AN EXPERIMENT SEARCHING FOR THE **LEPTON FLAVOUR VIOLATING** DECAY



Here et al a service of the service

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MOTIVATION $\mu \rightarrow$ eee can occur in the Standard Model of Particle

Physics via neutrino mixing. It is however supressed to an unobservably low branching fraction **«10-**⁵⁰.

Many models for physics beyond the Standard Model **predict lepton flavor violation**.

Requirements

- best possible momentum resolution Energies < 52.8 MeV (Michel Spectrum) cause the momentum resolution to be multiple Coulomb scattering dominated

tracks.

Recurling tracks combine a

10 cm

• low material budget







Any observation $\mu \rightarrow eee$ is a sign for new physics.

 $B(\mu \rightarrow eee) < 1.0 \cdot 10^{-12}$ (SINDRUM, 1988) find or exclude $\mu \rightarrow eee$ at a 10⁻¹⁶ level State: Goal:

10-17 10-18 **10**⁻¹⁹ 3 4 5 6 m_µ - E_{tot} (MeV) 2

 good vertex resolution good timing resolution

For measuring in a reasonable time periode ~year • high rates: stop up to $2\cdot10^{9} \mu/s$

Environment

Solenoid Magnet ~1T

• Cooling using gaseous Helium

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ω ω

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large lever arm with a high acceptance for low momentum Combinatorial

• e^+ from ordinary μ^+ decay • e- from photon conversion, etc. • no coincidence

µ-Beam at PSI

Ε

2.6

- 2.3 mA, 590 MeV/c proton beam
- Phase I: ~10⁸ μ/s from target E (polerized μ)
 Phase II: 2·10⁹ μ/s from HiMB (planned)

TARGET

hollow double cone, ~70 µm Aluminum

36 cm

• large area for vertex separation

phase I

inner dou 2.8 TRACKING: PIXEL SENSORS

High Voltage Monolithic Active Pixel Sensors (**HV-MAPS**) manufactured in a commercial 180 nm CMOS process house the pixel electronics inside a deep N-well . Due to the high voltage (~70 V) the depletion zone is very thin which allows to thin the chips $< 50 \ \mu m$. In total **4860 sensors** with over 270 million **(80 x**) **80 µm²) pixels** of 1x2 and 2x2 cm² are used.



TIMING I: SCINTILATING FIBRES

ES

Between 2 and 4 layers of scintilating fibres with a diameter of **250 µm** in the middle barrel provide a first timing measurment of a few 100 ps. Fibres are used to reduce the material and hence multiple scatering inside the detector. In total ~4000 fibres are used and red out with Silicon photo multipliers (SiPM).

phase II

TIME II: SCINTILATING TILES

In the recurl stations relative thick ~1 cm scintilating tiles are used for a precise time measurment ~100 ps. In total ~7000 tiles are used.



length: 36 cm diameter: 12 cm



KAPTON FLEXPRINTS

height

Kapton-Aluminum (12 µm) flexprints are used inside the active detector for **LVDS** signal lines

Readout Concept

A triggerless data acquisition system processed ~1 Tbit/s **zero-suppressed** data. Up to 10⁹ tracks per seconds are reconstructed online on a graphical processing units (**GPU**) based filterfarm and reduced to ~100 Mbyte/s for offline storage and analysis.

Optical Links

Optical links connect the active detector with the filterfarm providing a galvanic separation.

and sensor supply.

litter 👯



1-level Eye diagrams are used to investigate the quality of optical links. width

0-level



Altera FPGAs are used for **preprocessing** (time sorting and merging) and transmitting the sensor data. Development Kits are used for various tests.



• parity controle on a 80 bit base is needed **6.4 Gbit/s** (BER < 10⁻¹⁶) • SFP: • QSFP: **11.3 Gbit/s** (BER < 10⁻¹⁶)